IEEE P802.11
Wireless LANs

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| TGbe Jan-Mar Teleconference Minutes |
| Date: 2023-03-08 |
| Author(s): |
| Name | Affiliation | Address | Phone | email |
| Jason Yuchen Guo | Huawei |  |  | guoyuchen@huawei.com |
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Abstract

This document contains the minutes for the IEEE 802.11 TGbe teleconferences from January 2023 to March 2023.

Revision history:

* Rev0: initial version of the document
* Rev1: add attendee list for the joint call, add the link for the PHY call, update the link for the MAC call

Abbreviations:

* C: Comment.
* A: Answer.

# 1st Conf. Call: March 6 (19:00–21:00 ET)–MAC

Please refer to the following link for the minutes

* https://mentor.ieee.org/802.11/dcn/23/11-23-0307-01-00be-minutes-for-tgbe-mac-ad-hoc-teleconferences-in-janeary-and-march-2023.docx

# 1st Conf. Call: March 6 (19:00–21:00 ET)–PHY

Please refer to the following link for the minutes

* https://mentor.ieee.org/802.11/dcn/23/11-23-0424-00-00be-tgbe-phy-ad-hoc-minutes-march-7-2023.docx

# 2nd Conf. Call: March 8 (10:00–12:00 ET)–JOINT

* The Chair, Alfred Asterjadhi (Qualcomm), calls the meeting to order
* IEEE 802 and 802.11 IPR policy and procedure
	+ **Patent Policy: Ways to inform IEEE:**
		- Cause an LOA to be submitted to the IEEE-SA (patcom@ieee.org); or
		- Provide the chair of this group with the identity of the holder(s) of any and all such claims as soon as possible; or
		- Speak up now and respond to this Call for Potentially Essential Patents

If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group and that are not already the subject of an Accepted Letter of Assurance, please respond at this time by providing relevant information to the WG Chair. **Nobody speaks/writes up**.

* + **Copyright Policy: Participants are advised that**
		- IEEE SA’s copyright policy is described in [Clause 7](https://standards.ieee.org/about/policies/bylaws/sect6-7.html#7) of the IEEE SA Standards Board Bylaws and [Clause 6.1](https://standards.ieee.org/about/policies/opman/sect6.html) of the IEEE SA Standards Board Operations Manual;
		- Any material submitted during standards development, whether verbal, recorded, or in written form, is a Contribution and shall comply with the IEEE SA Copyright Policy
		- **Copyright Policy was presented.**
	+ **Patent, Participation, Copyright and policy related subclause:** Please refer to Patent And Procedures
* Attendance reminder.
	+ Participation slide: <https://mentor.ieee.org/802-ec/dcn/16/ec-16-0180-05-00EC-ieee-802-participation-slide.pptx>
	+ Please record your attendance during the conference call by using the IMAT system:
		- 1) login to [imat](https://imat.ieee.org/attendance), 2) select “802.11 Telecons (<Month>)” entry, 3) select “C/LM/WG802.11 Attendance” entry, 4) click “<Joint TGbe > conference call that you are attending.
	+ If you are unable to record the attendance via [IMAT](https://imat.ieee.org/attendance) then please send an e-mail to Jason Y. Guo (guoyuchen@huawei.com) and Alfred Asterjadhi (asterjadhi@gmail.com)
	+ Please ensure that the following information is listed correctly when joining the call:
		- "[voter status] First Name Last Name (Affiliation)"
	+ Attendee List

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| --- | --- | --- | --- |
| Breakout | Timestamp | Name | Affiliation |
| TGbe (Joint) | 3/8 | Ajami, Abdel Karim | Qualcomm Technologies, Inc |
| TGbe (Joint) | 3/8 | Ansley, Carol | Cox Communications Inc. |
| TGbe (Joint) | 3/8 | baron, stephane | Canon Research Centre France |
| TGbe (Joint) | 3/8 | Bredewoud, Albert | Broadcom Corporation |
| TGbe (Joint) | 3/8 | CHENG, yajun | Xiaomi Communications Co., Ltd. |
| TGbe (Joint) | 3/8 | Choi, Jinsoo | LG ELECTRONICS |
| TGbe (Joint) | 3/8 | CHUN, JINYOUNG | LG ELECTRONICS |
| TGbe (Joint) | 3/8 | Chung, Chulho | SAMSUNG |
| TGbe (Joint) | 3/8 | Dong, Xiandong | Xiaomi Communications Co., Ltd. |
| TGbe (Joint) | 3/8 | Erkucuk, Serhat | Ofinno |
| TGbe (Joint) | 3/8 | Fan, Shuang | Sanechips Technology Co., Ltd. |
| TGbe (Joint) | 3/8 | Fang, Yonggang | Mediatek |
| TGbe (Joint) | 3/8 | Fischer, Matthew | Broadcom Corporation |
| TGbe (Joint) | 3/8 | Fujimori, Yuki | Canon Research Centre France |
| TGbe (Joint) | 3/8 | Guo, Yuchen | Huawei Technologies Co., Ltd |
| TGbe (Joint) | 3/8 | Hervieu, Lili | Cable Television Laboratories Inc. (CableLabs) |
| TGbe (Joint) | 3/8 | Ho, Duncan | Qualcomm Incorporated |
| TGbe (Joint) | 3/8 | Huang, Po-Kai | Intel |
| TGbe (Joint) | 3/8 | Huq, Kazi Mohammed Saidul | Ofinno |
| TGbe (Joint) | 3/8 | Inohiza, Hirohiko | Canon |
| TGbe (Joint) | 3/8 | Jang, Insun | LG ELECTRONICS |
| TGbe (Joint) | 3/8 | Kamel, Mahmoud | InterDigital, Inc. |
| TGbe (Joint) | 3/8 | Kim, Geon Hwan | LG ELECTRONICS |
| TGbe (Joint) | 3/8 | Kim, Sanghyun | WILUS Inc |
| TGbe (Joint) | 3/8 | Kim, Youhan | Qualcomm Technologies, Inc. |
| TGbe (Joint) | 3/8 | Kipness, Michael | IEEE Standards Association (IEEE SA) |
| TGbe (Joint) | 3/8 | Kishida, Akira | Nippon Telegraph and Telephone Corporation (NTT) |
| TGbe (Joint) | 3/8 | Lanante, Leonardo | Ofinno |
| TGbe (Joint) | 3/8 | Lee, Wookbong | Apple Inc. |
| TGbe (Joint) | 3/8 | Li, Jialing | Qualcomm Technologies, Inc. |
| TGbe (Joint) | 3/8 | Li, Weiyi | Spreadtrum |
| TGbe (Joint) | 3/8 | li, yan | ZTE Corporation |
| TGbe (Joint) | 3/8 | Li, Yapu | Guangdong OPPO Mobile Telecommunications Corp.,Ltd |
| TGbe (Joint) | 3/8 | Lim, Dong Guk | LG ELECTRONICS |
| TGbe (Joint) | 3/8 | Lou, Hanqing | InterDigital, Inc. |
| TGbe (Joint) | 3/8 | Lu, Liuming | Guangdong OPPO Mobile Telecommunications Corp.,Ltd |
| TGbe (Joint) | 3/8 | Ma, Yongsen | SAMSUNG ELECTRONICS |
| TGbe (Joint) | 3/8 | MAO, ZHI | Huawei Technologies Co., Ltd |
| TGbe (Joint) | 3/8 | Nayak, Peshal | Samsung Research America |
| TGbe (Joint) | 3/8 | Nezou, Patrice | Canon Research Centre France |
| TGbe (Joint) | 3/8 | Patil, Abhishek | Qualcomm Incorporated |
| TGbe (Joint) | 3/8 | Quan, Yingqiao | Unisoc |
| TGbe (Joint) | 3/8 | Ratnam, Vishnu | Samsung Research America |
| TGbe (Joint) | 3/8 | Shafin, Rubayet | Samsung Research America |
| TGbe (Joint) | 3/8 | Shilo, Shimi | Huawei Technologies Co., Ltd |
| TGbe (Joint) | 3/8 | Tsodik, Genadiy | Huawei Technologies Co., Ltd |
| TGbe (Joint) | 3/8 | VIGER, Pascal | Canon Research Centre France |
| TGbe (Joint) | 3/8 | Wang, Qi | Apple, Inc. |
| TGbe (Joint) | 3/8 | Wang, Xiaofei | InterDigital, Inc. |
| TGbe (Joint) | 3/8 | Wei, Dong | NXP Semiconductors |
| TGbe (Joint) | 3/8 | Wullert, John | Peraton Labs |
| TGbe (Joint) | 3/8 | Xia, Qing | Sony Corporation |
| TGbe (Joint) | 3/8 | Yang, Jay | Nokia |
| TGbe (Joint) | 3/8 | YANG, RUI | InterDigital, Inc. |
| TGbe (Joint) | 3/8 | Yano, Kazuto | Advanced Telecommunications Research Institute International (ATR) |
| TGbe (Joint) | 3/8 | Yoon, Yelin | LG ELECTRONICS |
| TGbe (Joint) | 3/8 | Zhou, Lei | H3C Technologies Co., Limited |
| TGbe (Joint) | 3/8 | Zhu, Minchen | XGIMI |

* **Announcements:** WG LB271 on TGbe D3.0 has passed with an approval rate of ~80%.
* Agenda
	+ **TGbe Editor’s Report:** [11-23/273r0](https://mentor.ieee.org/802.11/dcn/23/11-23-0273-00-00be-tgbe-editor-s-report-on-lb271.ppt)
	+ **Comment Assignment from Joint tab:** [11-23/272r5](https://mentor.ieee.org/802.11/dcn/23/11-23-0272-05-00be-ieee-802-11be-lb271-comments.xlsx)
	+ **Guideline Review** (for the upcoming resolution round): [11-22/874r15](https://mentor.ieee.org/802.11/dcn/20/11-20-0984-15-00be-tgbe-teleconference-guidelines.docx)
	+ Discussions
		- None
	+ Agenda approved with unanimous consent
* **TGbe Editor’s Report:** [11-23/273r0](https://mentor.ieee.org/802.11/dcn/23/11-23-0273-00-00be-tgbe-editor-s-report-on-lb271.ppt)

The chair went through the editor’s report since the editor (Edward Au, Huawei) is unable to attend this meeting.

* **Comment Assignment from Joint tab:** [11-23/272r5](https://mentor.ieee.org/802.11/dcn/23/11-23-0272-05-00be-ieee-802-11be-lb271-comments.xlsx)

The chair went through the comment spreadsheet focusing the unassigned CIDs in the joint tab, and assigned each of the CIDs to the corresponding volunteers.

* **Guideline Review** (for the upcoming resolution round): [11-22/874r15](https://mentor.ieee.org/802.11/dcn/20/11-20-0984-15-00be-tgbe-teleconference-guidelines.docx)

The chair went through the guideline for the CR in this round.

* **Preparations** for the March plenary session:
	+ Call for CR submissions for the plenary session.
		- Please send the requests by Sunday, 12 March, 4:00pm, ET.
		- PS: Recommended but not required to have the doc uploaded by that time.
* **Preliminary Planning** for Telcos and MAC Ad-hocs:
	+ Telcos expected to have same cadence as last round.
		- Weekly MAC/PHY on Monday (19-21 ET)
		- Biweekly MAC on Thursday (10-12 ET)
		- Biweekly alternate MAC/Joint on Wednesday (10-12 ET)
		- Discussions:
			* Arik asked to use the same schedule as last round, i.e., loop (Monday+ Wednesday for one week, Wednesday+Thursday for the other week)
			* The chair will consider and double check.
	+ Plans for MAC Ad-hocs for May and July.
		- MAC Ad-hoc prior to May interim
			* **Option 1:** 3-day (possibly 10-12 May 2023, location TBD)
				+ Candidate locations:
			* **Option 2:** 2-day (12-13 May, Fri-Sat) Orlando, Florida, same hotel as interim. Pending sponsor.
		- MAC Ad-hoc prior to July plenary
			* 3-day MAC ad-hoc in Europe (near Berlin)?
				+ Candidate locations:
	+ Finalize next week.
* AoB: None
* Adjourned at 10:43